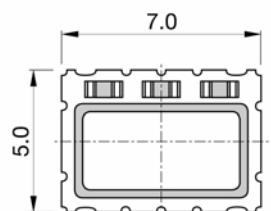


Specifications

Nominal Frequency F ₀	50.0000 MHz	
Frequency stability:		
vs. temperature	≤±0.5 ppm over -40 ~ +85 °C;	
	≤± 3.0 ppm over -55C to -40C and over +85C to +95C	
vs. supply change	≤±0.2 ppm	±5 %
vs. load change	≤±0.1 ppm	±5 %
vs. aging:	≤±1.0 ppm	1st year
Short term stability ADEV	< 1 x 10 ⁻¹⁰	τ = 1 sec.
Frequency tolerance ex factory	≤ ±1.0 ppm	@+25 °C
Supply voltage	+3.3 V	±5 %
Current consumption	< 10 mA	
Output waveform	>1V p-p	Clipped sine wave
Output load	10Kohm // 10 pF	
Start-up time	< 5 ms	
Tri-state function	pin # 9 high or open pin # 9 low	pin # 6 → oscillation pin # 6 → high Impedance
Phase noise @ 50 MHz carrier frequency	-110 dBc/Hz -130 dBc/Hz -145 dBc/Hz	@ 100 Hz @ 1 kHz @ 10 kHz
Operating temperature range	-55 ~ +95 °C	
Storage temperature range	-55 ~ +125 °C	
Packing units	tape & reel	500 or 1'000 pcs

Mechanical Drawing and PIN Connection



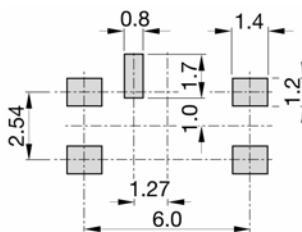
Pin function

- # 1 not connected
5 GND
6 Output
9 NC or E/D
10 Vdc

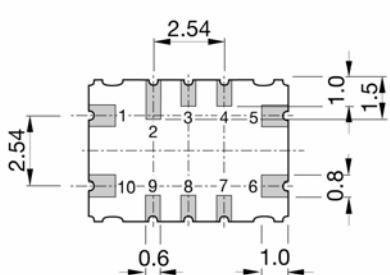
Do not connect
#2, #3, #4, #7, #8



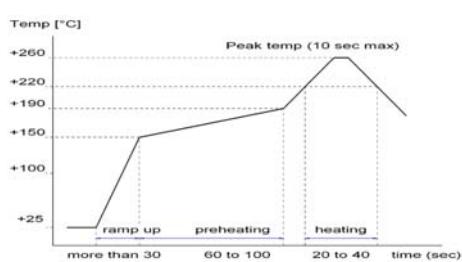
Example for solder pattern



Do not design any conductive path between the pattern



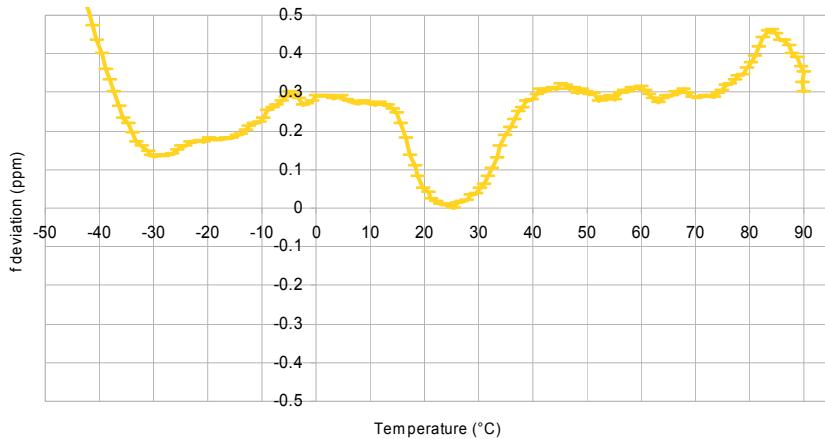
Do not design any conductive path between Example for IR reflow soldering temperature



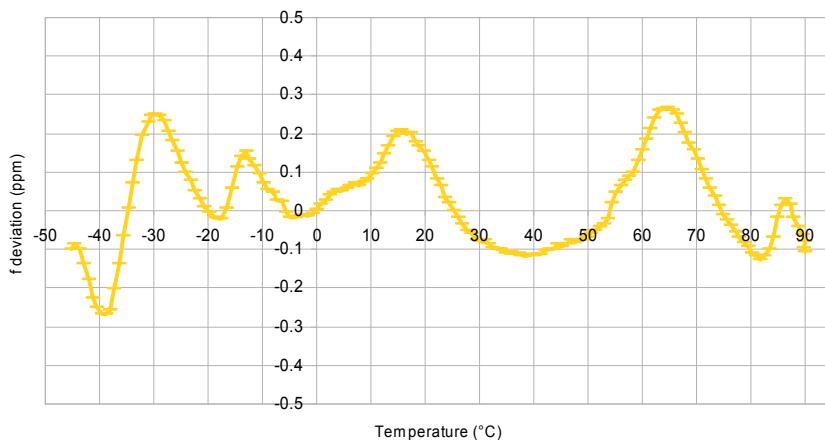
Final Inspection Test Data

1. Frequency deviation vs. temperature, measured over -45 up to +90 °C

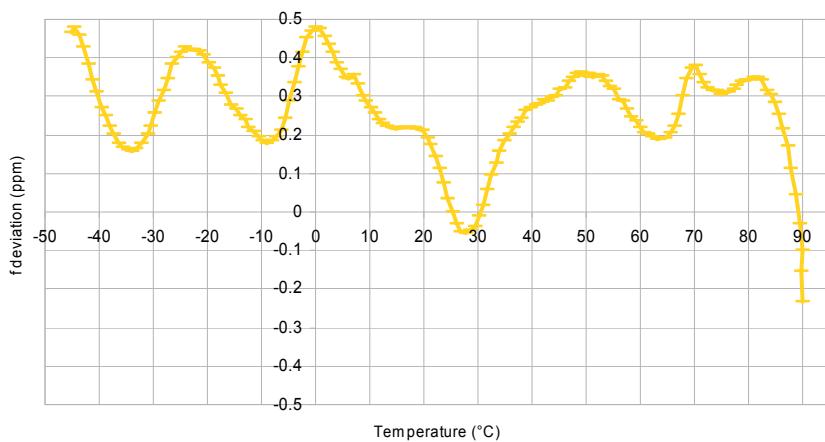
No: 1-23



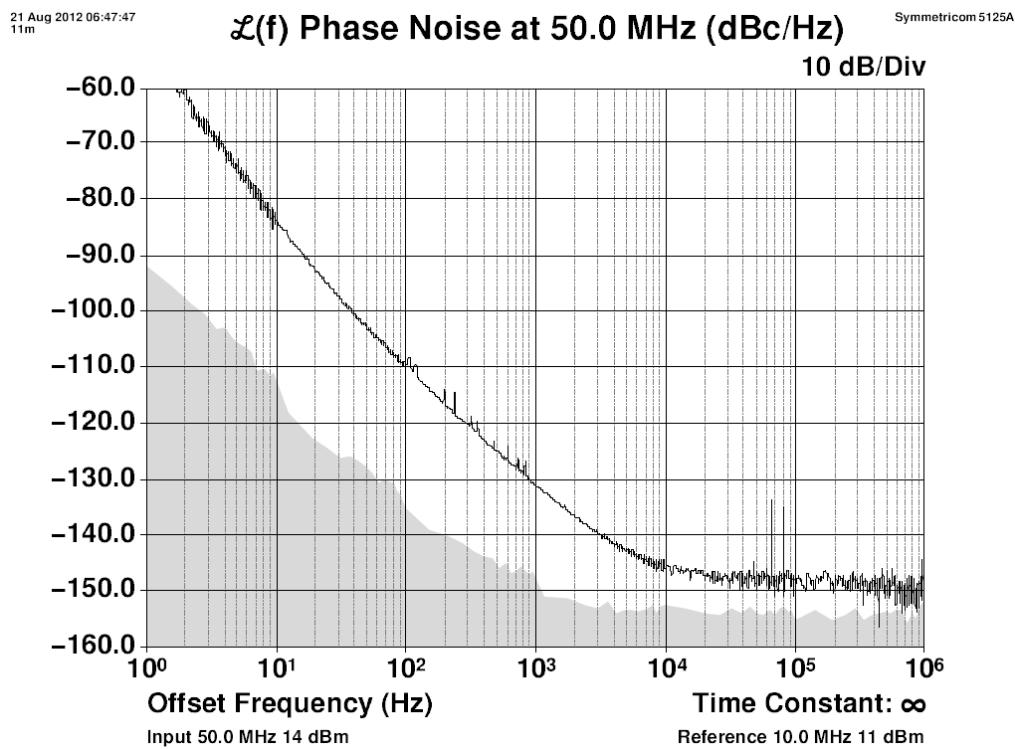
No: 2-16



No: 3-15



2. Phase noise



3. ADEV

